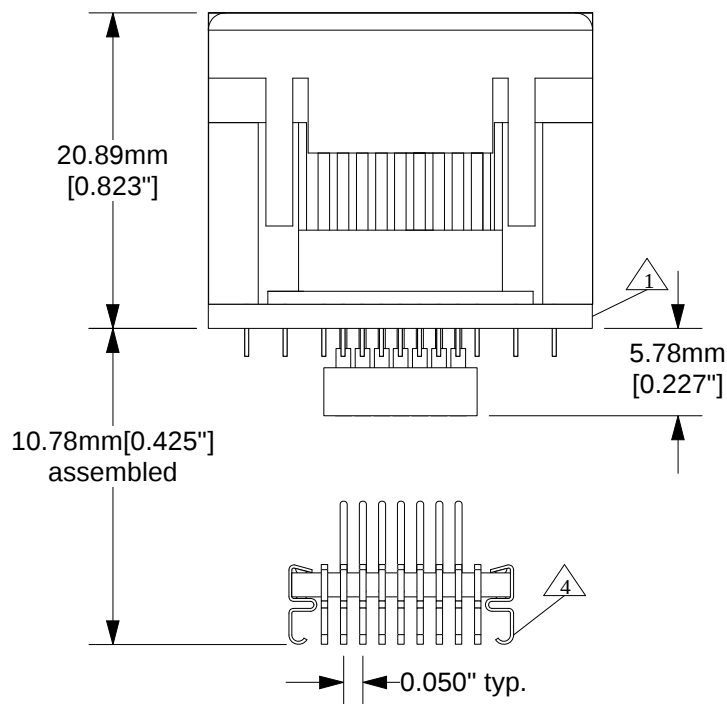
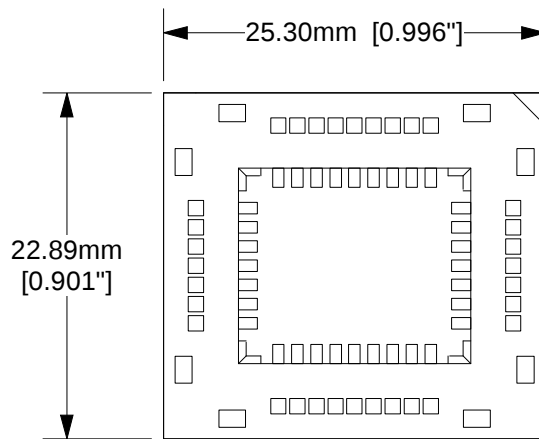




- △1 Substrate: 1.59mm $\pm$ 0.18mm [0.0625" $\pm$ 0.007"]
FR4/G10 or equivalent high temp material. 17 μ m [1/2 oz.] Cu clad. SnPb plating.
- △4 Leads: material- BeCu Alloy 194; plating- 60/40 SnPb 3.80-10.16 μ m [150-400 μ "].

Description: Carrier Adapter

32 position PLCC ZIF socket to surface mountable PLCC emulator foot. Two piece adaptor interconnects via a gold plated mini-grid socket interface.

Tolerances: diameters $\pm$ 0.03mm [$\pm$ 0.001"], PCB perimeters $\pm$ 0.13mm [$\pm$ 0.005"], PCB thicknesses $\pm$ 0.18mm [$\pm$ 0.007"], pitches (from true e position) $\pm$ 0.08mm [$\pm$ 0.003"], all other tolerances $\pm$ 0.13mm [$\pm$ 0.005"] unless stated otherwise.

CA-PLCC32-Z-J-01 Drawing		Status: Released	Scale 2:1	Rev: A
 © 2002 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing: W. Watson		Date: 1/4/02	
	File: CA-PLCC032-Z-J-01 Dwg		Modified:	